TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSIII)

2SK2884

Chopper Regulator, DC-DC Converter Applications

Unit: mm

 $\begin{array}{ll} \bullet & \text{Low drain-source ON resistance} & : \text{RDS (ON)} = 1.9 \ \Omega \ \text{(typ.)} \\ \bullet & \text{High forward transfer admittance} & : |Y_{fs}| = 3.8 \ \text{S (typ.)} \\ \bullet & \text{Low leakage current} & : \text{IDSS} = 100 \ \mu\text{A (max)} \ \text{(VDS} = 640 \ \text{V)} \\ \end{array}$

• Enhancement-mode : $V_{th} = 2.0 \sim 4.0 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA})$

Maximum Ratings (Tc = 25°C)

| Characteristics | | Symbol | Rating | Unit | |
|--|----------------|------------------|---------|------|--|
| Drain-source voltage | | V_{DSS} | 800 | V | |
| Drain-gate voltage (R _{GS} = 20 kΩ) | | V_{DGR} | 800 | V | |
| Gate-source voltage | | V _{GSS} | ±30 | V | |
| Drain current | DC (Note 1) | I _D | 5 | Α | |
| | Pulse (Note 1) | I _{DP} | 15 | Α | |
| Drain power dissipation | | P _D | 100 | W | |
| Single pulse avalanche energy (Note 2) | | E _{AS} | 370 | mJ | |
| Avalanche current | | I _{AR} | 5 | Α | |
| Repetitive avalanche energy (Note 3) | | E _{AR} | 10 | mJ | |
| Channel temperature | | T _{ch} | 150 | °C | |
| Storage temperature range | | T _{stg} | -55~150 | °C | |

Thermal Characteristics

| Characteristics | Symbol | Max | Unit |
|--|------------------------|------|------|
| Thermal resistance, channel to case | R _{th (ch-c)} | 1.25 | °C/W |
| Thermal resistance, channel to ambient | R _{th (ch-a)} | 83.3 | °C/W |

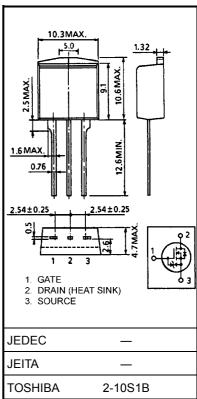
Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 27 mH, R_G = 25 Ω , I_{AR} = 5 A

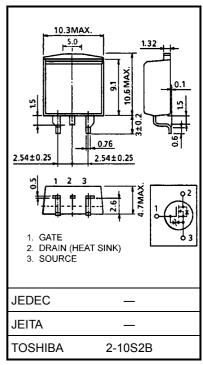
Note 3: Repetitive rating; Pulse width limited by maximum channel temperature.

This transistor is an electrostatic sensitive device.

Please handle with caution.



Weight: 1.5 g (typ.)



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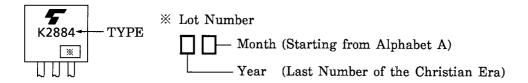
Electrical Characteristics (Tc = 25°C)

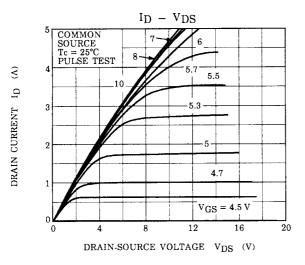
| Charac | eteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|---|-----------------|-----------------------|--|-----|------|-----|------|
| Gate leakage cu | ırrent | I _{GSS} | V _{GS} = ±30 V, V _{DS} = 0 V | _ | _ | ±10 | μΑ |
| Gate-source bro | eakdown voltage | V _(BR) GSS | $I_G = \pm 10 \ \mu A, \ V_{DS} = 0 \ V$ | ±30 | - | 1 | V |
| Drain cut-off cu | rrent | I _{DSS} | V _{DS} = 640 V, V _{GS} = 0 V | - | | 100 | μΑ |
| Drain-source br | eakdown voltage | V _{(BR)DSS} | I _D = 10 mA, V _{GS} = 0 V | 800 | _ | _ | V |
| Gate threshold v | voltage | V_{th} | V _{DS} = 10 V, I _D = 1 mA | 2.0 | _ | 4.0 | V |
| Drain-source O | N resistance | R _{DS} (ON) | V _{GS} = 10 V, I _D = 3 A | _ | 1.9 | 2.2 | Ω |
| Forward transfe | r admittance | Y _{fs} | V _{DS} = 15 V, I _D = 3 A | 1.0 | 3.8 | _ | S |
| Input capacitano | e | C _{iss} | | _ | 1080 | _ | |
| Reverse transfe | r capacitance | C _{rss} | V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz | _ | 16 | _ | pF |
| Output capacitance | | C _{oss} | | _ | 105 | _ | |
| Switching time | Rise time | t _r | $V_{\rm GS}$ $V_{\rm OUT}$ $V_{\rm OUT}$ $V_{\rm DD}$ $V_{\rm OUT}$ $V_{\rm DD}$ | _ | 40 | _ | |
| | Turn-on time | t _{on} | | ı | 80 | ı | ne |
| | Fall time | t _f | | _ | 40 | _ | ns |
| | Turn-off time | t _{off} | Duty $\leq 1\%$, $t_{\mathbf{W}} = 10 \mu s$ | _ | 140 | _ | |
| Total gate charge (gate-source plus gate-drain) | | Qg | | _ | 34 | _ | |
| Gate-source charge | | Q _{gs} | $V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$ | | 16 | _ | nC |
| Gate-drain ("miller") Charge | | Q _{gd} | | | 18 | _ | |

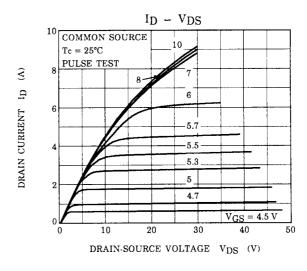
Source-Drain Ratings and Characteristics (Tc = 25°C)

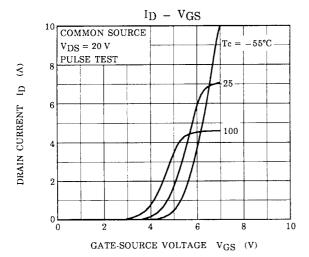
| Characteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|---|------------------|--|-----|------|------|------|
| Continuous drain reverse current (Note 1) | $I_{ m DR}$ | _ | ı | ı | 5 | Α |
| Pulse drain reverse current (Note 1) | I _{DRP} | _ | | | 15 | Α |
| Forward voltage (diode) | V _{DSF} | I _{DR} = 5 A, V _{GS} = 0 V | 1 | | -1.9 | V |
| Reverse recovery time | t _{rr} | I _{DR} = 5 A, V _{GS} = 0 V | 1 | 1000 | 1 | ns |
| Reverse recovery charge | Q_{rr} | dI _{DR} / dt = 100 A / μs | | 7.5 | 1 | μC |

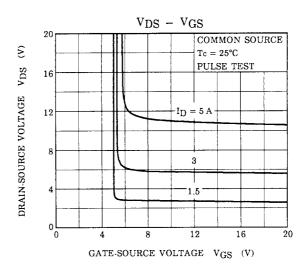
Marking

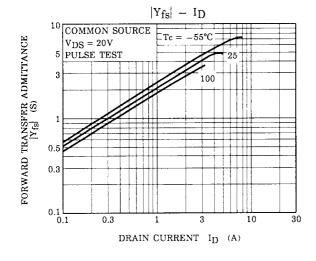


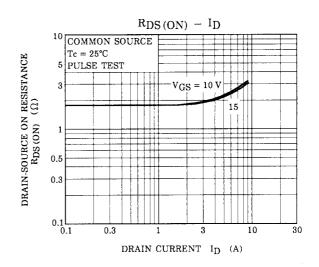




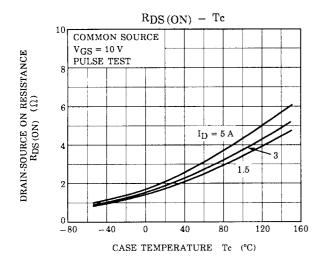


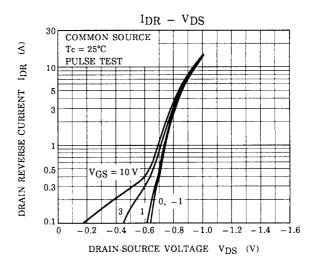


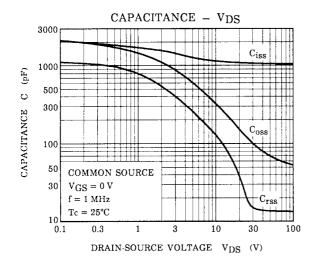


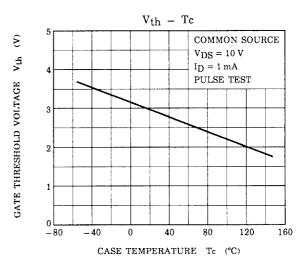


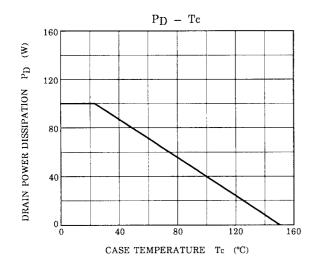
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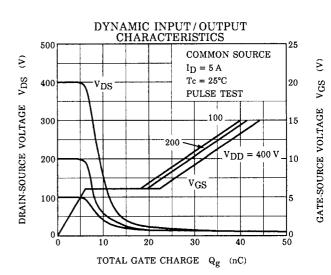


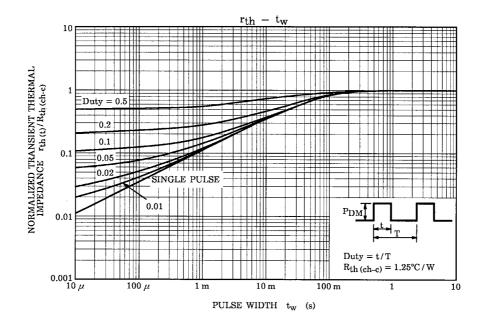


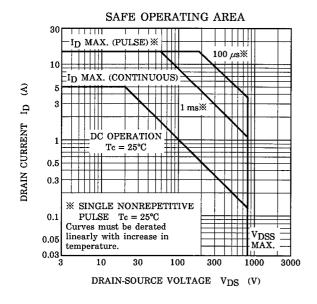


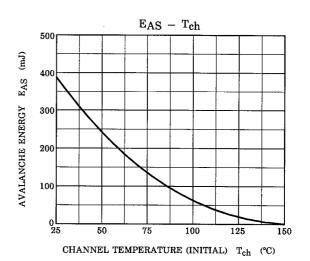


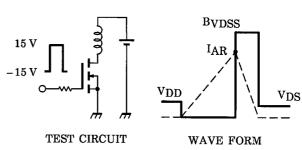












$$R_G = 25 \Omega$$

 $V_{DD} = 90 V$, $L = 27 mH$

$$E_{AS} = \frac{1}{2} \cdot L \cdot I^{2} \cdot \left(\frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right)$$

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